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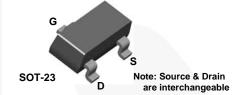


February 2015

# MMBF4117 / MMBF4118 / MMBF4119 N-Channel Switch

# **Description**

This device is designed for low current DC and audio applications. These devices provide excellent performance as input stages for sub-picoamp instrumentation or any high impedance signal sources. Sourced from process 53.



# **Ordering Information**

| Part Number | Top Mark | Package   | Packing Method |
|-------------|----------|-----------|----------------|
| MMBF4117    | 61A      | SOT-23 3L | Tape and Reel  |
| MMBF4118    | 61C      | SOT-23 3L | Tape and Reel  |
| MMBF4119    | 61E      | SOT-23 3L | Tape and Reel  |

# **Absolute Maximum Ratings**(1), (2)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25^{\circ}\text{C}$  unless otherwise noted.

| Symbol                            | Parameter  | Value       | Unit |
|-----------------------------------|--|-------------|------|
| V <sub>DG</sub>                   | Drain-Gate Voltage                               | 40          | V    |
| $V_{GS}$                          | Gate-Source Voltage                              | -40         | V    |
| I <sub>GF</sub>                   | Forward Gate Current                             | 50          | mA   |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Junction Temperature Range | -55 to +150 | °C   |

## Notes:

- 1. These ratings are based on a maximum junction temperature of 150°C.
- 2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty-cycle operations.

# Thermal Characteristics(3)

Values are at  $T_A = 25$ °C unless otherwise noted.

| Symbol          | Parameter                               | Max. | Unit  |
|-----------------|---|------|-------|
| P <sub>D</sub>  | Total Device Dissipation                | 225  | mW    |
|                 | Derate Above 25°C                       | 1.8  | mW/°C |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | 556  | °C/W  |

## Note:

3. Device mounted on FR-4 PCB 1.6 inch X 1.6 inch X 0.06 inch.

## **Electrical Characteristics**

Values are at  $T_A = 25$ °C unless otherwise noted.

| Symbol               | Parameter   | Conditions  | 3        | Min. | Max. | Unit  |
|----------------------|---|---|----------|------|------|-------|
| Off Chara            | cteristics  |   |          |      |      | 1     |
| V <sub>(BR)GSS</sub> | Gate-Source Breakdown Voltage $I_G = -1.0 \mu A$ , $V_{DS} = 0$ |   |          | -40  |      | V     |
| I <sub>GSS</sub>     | Gate Reverse Current  | $V_{GS} = -20 \text{ V}, V_{DS} = 0$                        |          |      | -10  | pA    |
|                      |   | $V_{GS} = -20 \text{ V}, V_{DS} = 0, T_A$                   | = 150°C  |      | -25  | nA    |
| V <sub>GS(off)</sub> | Gate-Source Cut-Off Voltage                                     | V <sub>DS</sub> = -10 V, I <sub>D</sub> = 1.0 nA            | MMBF4117 | -0.6 | -1.8 | V     |
|                      |   |   | MMBF4118 | -1.0 | -3.0 |       |
|                      |   |   | MMBF4119 | -2.0 | -6.0 |       |
| On Chara             | cteristics  |   | <u> </u> |      | •    |       |
| I <sub>DSS</sub> Z   | Zero-Gate Voltage Drain<br>Current <sup>(4)</sup>               | V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0                 | MMBF4117 | 30   | 90   | μΑ    |
|                      |   |   | MMBF4118 | 80   | 240  |       |
|                      |   |   | MMBF4119 | 200  | 600  |       |
| Small Sig            | nal Characteristics   |   | <u> </u> |      | •    |       |
|                      |   | V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0,<br>f = 1.0 kHz | MMBF4117 | 70   | 210  | μmhos |
| α.                   |   |   | MMBF4118 | 80   | 250  |       |
|                      |   |   | MMBF4119 | 100  | 330  |       |
|                      | Common-Source Output<br>Conductance                             | V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0,<br>f = 1.0 kHz | MMBF4117 |      | 3.0  | μmhos |
| (1                   |   |   | MMBF4118 |      | 5.0  |       |
|                      |   |   | MMBF4119 |      | 10.0 |       |
| $R \sim 1$           | Common-Source Forward<br>Transconductance                       | $V_{DS} = 10 \text{ V}, V_{GS} = 0,$<br>f = 30 MHz          | MMBF4117 | 60   |      | μmhos |
|                      |   |   | MMBF4118 | 70   |      |       |
|                      |   |   | MMBF4119 | 90   |      |       |
| C <sub>iss</sub>     | Input Capacitance   | V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0, f = 1.0 kHz    |          |      | 3.0  | pF    |
| C <sub>rss</sub>     | Reverse Transfer Capacitance                                    | $V_{DS} = 10 \text{ V}, V_{GS} = 0, f =$                    | 1.0 MHz  |      | 1.5  | pF    |

## Note:

4. Pulse test: pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  1.0%

# **Typical Performance Characteristics**

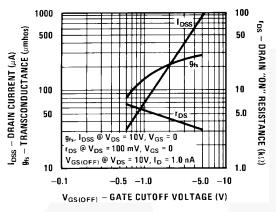


Figure 1. Parameter Interactions

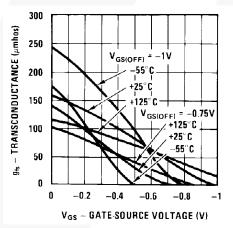


Figure 3. Transfer Characteristics

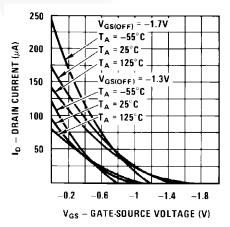


Figure 5. Transfer Characteristics

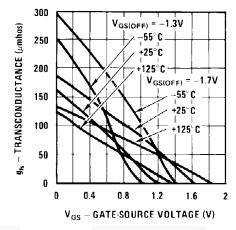


Figure 2. Transfer Characteristics

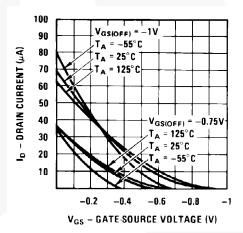


Figure 4. Transfer Characteristics

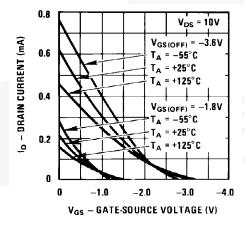


Figure 6. Transfer Characteristics

# **Typical Performance Characteristics** (Continued)

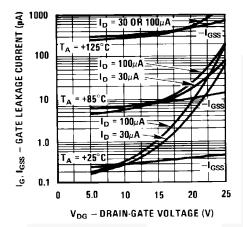


Figure 7. Leakage Current vs. Voltage

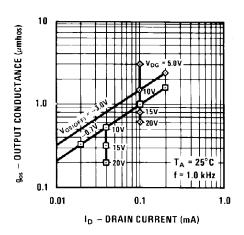


Figure 9. Output Conductance vs. Drain Current

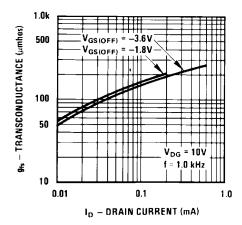


Figure 11. Transconductance vs. Drain Current

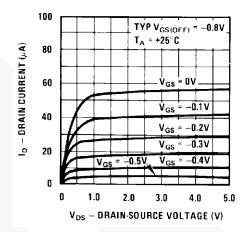


Figure 8. Common Drain-Source

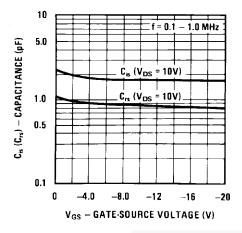


Figure 10. Conductance vs. Voltage

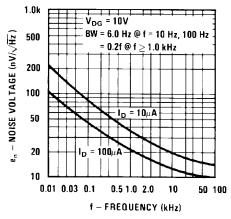


Figure 12. Noise Voltage vs. Frequency

# **Physical Dimensions** 0.95 2.92±0.20 3 1.40 1.30+0.20 2.20 2 0.60 0.37 (0.29) -0.95 ⊕ 0.20M A B 1.00 1.90 1.90 LAND PATTERN RECOMMENDATION SEE DETAIL A -1.20 MAX 0.10 (0.93) ○ 0.10 M C С 2.40±0.30 NOTES: UNLESS OTHERWISE SPECIFIED

SCALE: 2X

**GAGE PLANE** 

0.23

0.20 MIN

(0.55)

**DETAIL A** 

Figure 13. 3-LEAD, SOT23, JEDEC TO-236, LOW PROFILE

0.25

**PLANE** 

A) REFERENCE JEDEC REGISTRATION TO-236, VARIATION AB, ISSUE H.

ASME Y14.5M - 1994.

SEATING E) DRAWING FILE NAME: MA03DREV10

B) ALL DIMENSIONS ARE IN MILLIMETERS.
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